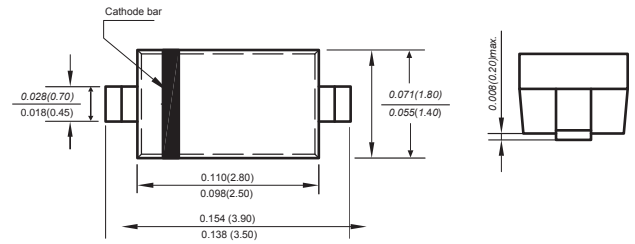


## FAST SWITCHING DIODES

### Features

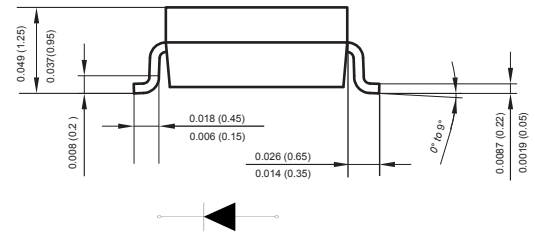
- ◆ Fast switching speed
- ◆ Surface mount package ideally suited
- ◆ for automatic insertion
- ◆ For general purpose switching applications High
- ◆ conductance

**SOD-123**



### Mechanical Data

Case: JEDEC SOD-123 molded plastic body  
 Terminals: Plated leads solderable per MIL-STD-750, Method 2026  
 Polarity: Polarity symbols marked on case  
 Marking: BAV19W:A8, BAV20W:T2, BAV21W:T3



Dimensions in inches and (millimeters)

### Absolute Maximum Ratings at 25 °C

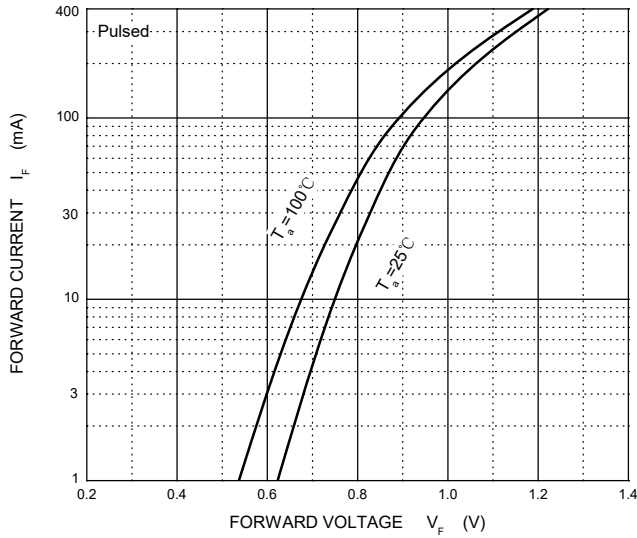
PARAMETER	SYMBOLS	BAV19W	BAV20W	BAV21W	UNITS
Non-Repetitive Peak Reverse Voltage	$V_{RM}$	120	200	250	V
Working Peak Reverse Voltage	$V_{RWM}$	100	150	200	V
Peak Repetitive Reverse Voltage	$V_{RRM}$				
RMS Reverse voltage	$V_{R(RMS)}$	71	106	141	V
Forward continuous current	$I_{FM}$	250			mA
Average rectified output current	$I_o$	200			mA
Peak forward surge current @=1s	$I_{FSM}$	1			A
@=1ms		3			
@=1us		9			
Repetitive peak forward current	$I_{FRM}$	625			mA
Power dissipation	$P_d$	500			mW
Thermal resistance junction to ambient	$R_{\theta JA}$	500			K/W
Junction Temperature	$T_j$	-55 to +150			°C
Storage Temperature	$T_{STG}$	-55 to +150			°C
Non-Repetitive peak reverse voltage	$V_{RM}$	120	200	250	V

### Characteristics at Ta= 25 °C

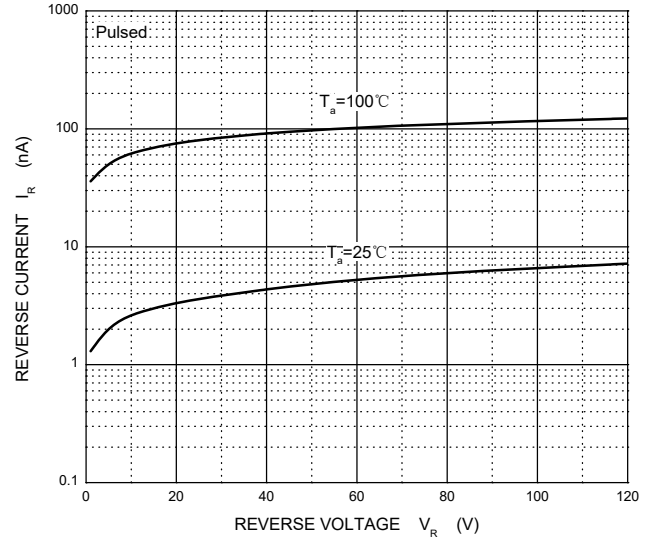
PARAMETER	SYMBOLS	Min.	Typ.	Max.	Unit	Conditions
Forward voltage	$V_{F1}$			1.0	V	$I_F=0.1A$
	$V_{F2}$			1.25	V	$I_F=0.2A$
Reverse current	$I_R$			0.1	uA	$V_R=100V$
				0.1	uA	$V_R=150V$
				0.1	uA	$V_R=200V$
Capacitance between terminals	$C_T$			5	pF	$V_R=0V, f=1.0MHz$
Reverse recovery time	$t_{rr}$			50	ns	$I_F=I_R=10mA$ $I_{rr}=0.1X I_R, R_L=100\Omega$

## Typical Characteristics

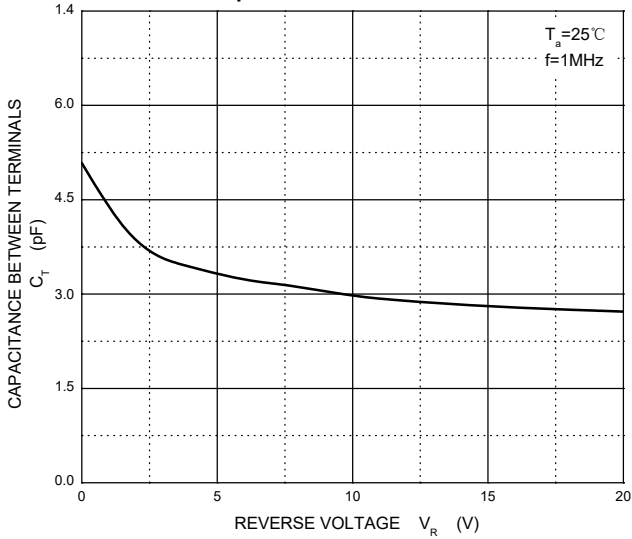
**Forward Characteristics**



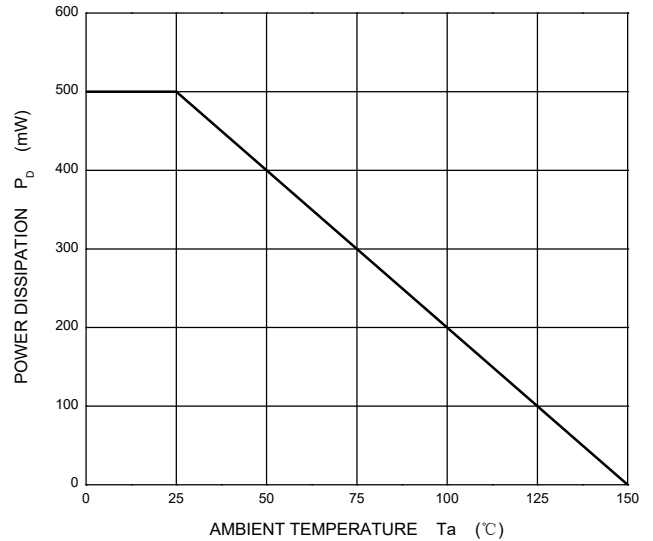
**Reverse Characteristics**



**Capacitance Characteristics**

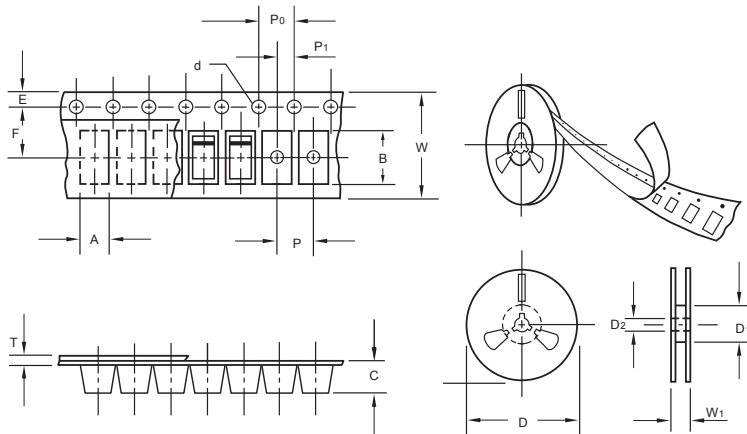


**Power Derating Curve**



The curve above is for reference only.

## Packing information



unit:mm

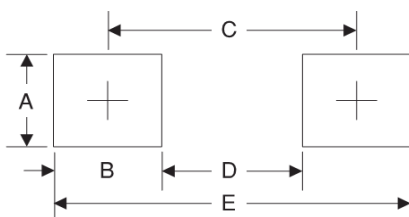
Item	Symbol	Tolerance	SOD-123
Carrier width	A	0.1	2.1
Carrier length	B	0.1	4.0
Carrier depth	C	0.1	1.60
Sprocket hole	d	0.05	1.55
7" Reel outside diameter	D	2.0	178.00
7" Reel inner diameter	D <sub>1</sub>	min	50.0
Feed hole diameter	D <sub>2</sub>	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	3.50
Punch hole pitch	P	0.1	4.00
Sprocket hole pitch	P <sub>0</sub>	0.1	4.00
Embossment center	P <sub>1</sub>	0.1	2.00
Overall tape thickness	T	0.1	0.25
Tape width	W	0.3	8.15
Reel width	W <sub>1</sub>	1.0	10.5

Note: Devices are packed in accordance with EIA standard RS-481-A and specifications listed above.

## Reel packing

PACKAGE	REEL SIZE	REEL (pcs)	COMPONENT SPACING (m/m)	BOX (pcs)	INNER BOX (m/m)	REEL DIA, (m/m)	CARTON SIZE (m/m)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
SOD-123	7"	3,000	4.0	45,000	190*190*190	178	400*400*220	180,000	9.0

## Suggested Pad Layout



Symbol	Unit (mm)	Unit (inch)
A	1.2	0.047
B	1.2	0.047
C	3.2	0.126
D	2.0	0.079
E	4.4	0.173

## Important Notice and Disclaimer

Microdiode Electronics (Shenzhen) reserves the right to make changes to this document and its products and specifications at any time without notice. Customers should obtain and confirm the latest product information and specifications before final design, purchase or use.

Microdiode Electronics (Shenzhen) makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Microdiode Electronics (Shenzhen) assume any liability for application assistance or customer product design. Microdiode Electronics (Shenzhen) does not warrant or accept any liability with products which are purchased or used for any unintended or unauthorized application.

No license is granted by implication or otherwise under any intellectual property rights of Microdiode Electronics (Shenzhen).

Microdiode Electronics (Shenzhen) products are not authorized for use as critical components in life support devices or systems without express written approval of Microdiode Electronics (Shenzhen).